

	<h1>Tentative</h1>	<b>DSA4G01</b>	
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# DSA4G01

Silicon PNP epitaxial planar type

For High-frequency Amplifier

Marking Symbol A4

Package Code : NS-B1-B-B

## Absolute Maximum Ratings $T_a = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	-30	V
Collector-emitter voltage (Base open)	VCEO	-20	V
Emitter-base voltage (Collector open)	VEBO	-5	V
Collector current	IC	-30	mA
Collector power dissipation	Pc	300	mW
Junction temperature	Tj	150	$^\circ\text{C}$
Storage temperature	Tstg	-55 to +150	$^\circ\text{C}$

Pin name	1.	Emitter
	2.	Collector
	3.	Base

## Electrical Characteristics $T_a = 25\text{ }^\circ\text{C} \pm 3\text{ }^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base cutoff current (Emitter open)	ICBO	VCB = -10 V, IE = 0			-0.1	$\mu\text{A}$
Collector-emitter cutoff current (Base open)	ICEO	VCE = -20 V, IB = 0			-100	$\mu\text{A}$
Emitter-base cutoff current (Collector open)	IEBO	VEB = -5 V, IC = 0			-10	$\mu\text{A}$
Forward current transfer ratio *1	hFE	VCE = -10 V, IC = -1 mA	70		220	-
Collector-emitter saturation voltage	VCE(sat)	IC = -10 mA, IB = -1 mA		-0.1		V
Base-emitter voltage	VBE	VCE = -10 V, IC = -1 mA		-0.7		V
Transition frequency	fT	VCE = -10 V, IC = -1 mA	150	300		MHz
Small-signal revers transfer capacitance	Cre	VCE = -10 V, IC = -1mA, f = 10.7 MHz		1.0		pF
Noise figuer	NF	VCE = -10 V, IC = -1 mA, f = 5 MHz		2.8		dB
Feedback impedance	Zrb	VCE = -10 V, IC = -1 mA, f = 2 MHz		22		$\Omega$

methods for transistors.

\*1 Rank classification

Code	B	C	0
Rank	B	C	No-rank
hFE	70 to 140	110 to 220	70 to 220
Marking symbol	A4B	A4C	A4

Product of no-rank is not classified and have no marking symbol for rank.

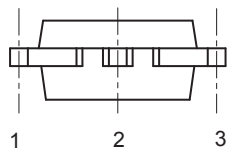
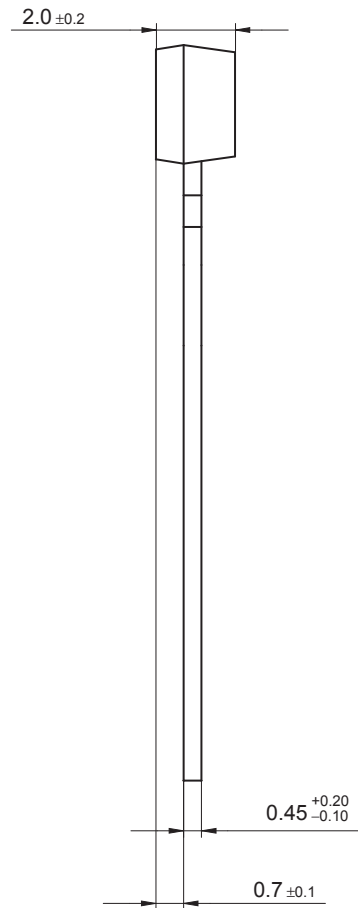
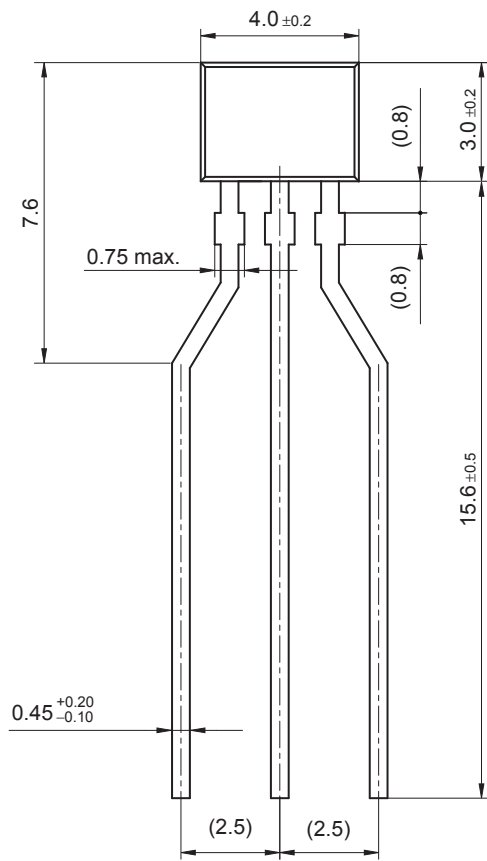
## Packing

Radial type : 5 000 pcs / carton

2010.2.23	2010.8.17	
Prepared	Revised	

NS-B1-B-B

Unit: mm



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